High precision Thin film, High stability and reliability type

High precision

Low TCR Anti solder joint crack

Antifurated Surge

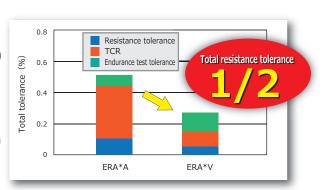
AEC-Q200

ERA*V/K series



Achieving higher-precision and longer-life than conventional*1 series

- ∨ Resistance tolerance ± 0.05 %
- √ TCR ± 10 ppm/°C
- ∨ Endurance test tolerance ± 0.1 %



Half total tolerance from thin film chip resistors (Conventional series)

- 1. High-precision, design margin securing and improve performance
- 2. Improve reliability in severe conditions

Point

Highest level of ESD resistance by preventing current concentration and reducing electric field strength

Anti-ESD

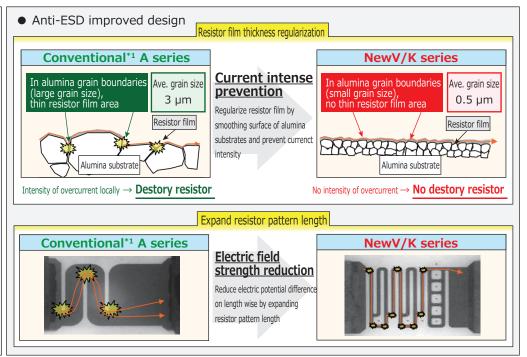
● ESD test (1 kΩ)
HBM: 150 pF,2 kV,±5 times
0603 Thin film chip resistors

ERA*A

■ ERA*V/K

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ERA*V/K series

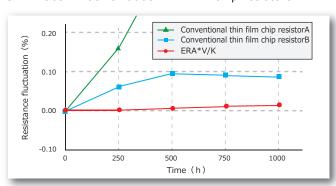
Improve anti-sulfurated by the introduction of edge sputtering electrode covering gap between protection film and electrode

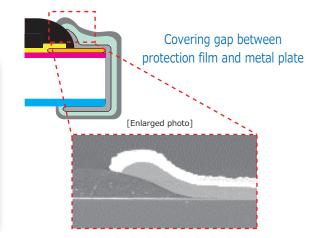
Anti-sulfurated

Point

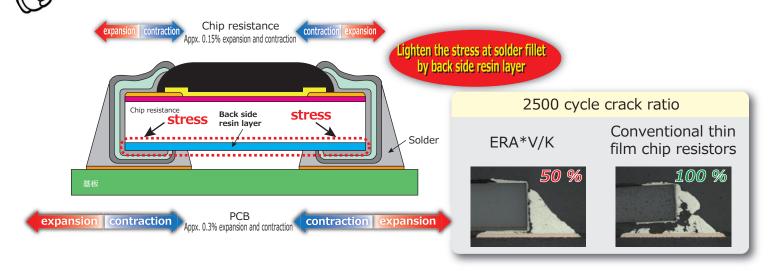
Point

Sulfurization gas test
 ASTM B809 : 105 ℃ 0603 Thin film chip resistors





Achieve excellent anti solder joint crack by back side resin layer



■ Specifications

- Specifications											
	Part No.	Size (inch)	Power rating (W)	Limiting element voltage (V)	Resistance tolerance (%)	Resistance range (Ω)	TCR (x10 ⁻⁶ / ℃)	ESD withstand voltage (kV)	Category temp. range (°C)	AEC-Q200	*1: Expanded resistance range
	ERA2V	0402	0.100	75	± 0.1 ±0.05	$1 \text{ k} \le \text{R} \le 47 \text{ k}^{*1}$ $47 \le \text{R} \le 100 \text{ k}^{*1}$	±15(P)	1.0			
	ERA3V ERA3K (100 kΩ over)	0603	0.125	100	± 0.1 ±0.05	$1 \text{ k} \le \text{R} \le 100 \text{ k}$ $47 \le \text{R} \le 240 \text{ k}$	+10(P)	1.5	FF to 1FF	Grade 0	Please visit our website for details!
	ERA6V ERA6K (100 kΩ over)	0805	0.250	150	± 0.1 ±0.05	$1 \text{ k} \le \text{R} \le 100 \text{ k}$ $47 \le \text{R} \le 750 \text{ k}$	±10(R) ±15(P)	2.0	-55 to 155		
	Under depelopment ERA8V ERA8K (100 kΩ over)	1206	0.250	150	± 0.1 ±0.05	1 k ≤ R ≤ 100 k	+10(R)	2.0			

±25(E)

47 ≦ R ≦ <u>1 M</u>